

- 1. Overall PCB Dimensions: xxxmm x xxxxmm
- 2. Route to shape on board outline layer .GM8.
- 3. PCB material shall be FR-4 with min Tg of 140C
- 4. Copper density shall be 1oz/sq in on all layers
- 5. Gold ENIG finish on pads
- 6. LPI solder mask color: Black
- 7. Legend color WHITE
- 8. Minimum drill size: 6mil
- 9. Minimum trace spacing: 5mil
- 10. Minimum trace width: 5mil
- 11. See file with .extrep extension for gerber layer assignments
- 12. NC Drill file will have a .txt extension
- 13. 4-Layer stackup with nominal 31.25mil finished thickness +/- 10%
- 14. Alternate stackup/materials may be used with prior written permission
- 15. PCB shall be fully electrically tested
- 16. 6mil via in pad under under BGA shall be plugged with non conductive fill and finish plated

Part	Number RT_SUPERMK_76	Rev A
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		Date
		2021-10-16
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